



### P-CHANNEL ENHANCEMENT MODE MOSFET

# **Product Summary**

BVDSS	Rds(ON) Max	I <sub>D</sub> Max T <sub>C</sub> = +25°C		
-12V	11.7m $\Omega$ @ V <sub>GS</sub> = -4.5V	-19A		
-12V	18.6mΩ @ $V_{GS} = -2.5V$	-15A		

# **Description**

This MOSFET is designed to minimize the on-state resistance (RDS(ON)) yet maintain superior switching performance, making it ideal for high efficiency power management applications. It is qualified to AEC-Q101, supported by a PPAP.

# **Applications**

- Backlighting
- Power Management Functions
- DC-DC Converters

# **Features and Benefits**

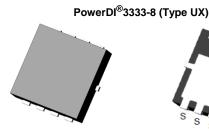
- Low Rds(ON) Ensures On-State Losses are Minimized
- Small Form Factor Thermally Efficient Package Enables Higher Density End Products
- Occupies just 33% of the Board Area Occupied by SO-8 Enabling Smaller End Product
- ESD Protected Up to 3kV
  - Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- The DMP1011LFVQ is suitable for automotive applications requiring specific change control; this part is AEC-Q101 qualified, PPAP capable, and manufactured in IATF16949 certified facilities.

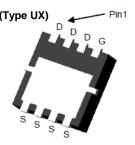
https://www.diodes.com/quality/product-definitions/

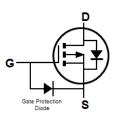
#### **Mechanical Data**

- Case: PowerDI<sup>®</sup>3333-8
- Case Material: Molded Plastic, "Green" Molding Compound.
   UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections Indicator: See Diagram
- Terminals: Finish Matte Tin Annealed over Copper Leadframe.
   Solderable per MIL-STD-202, Method 208 <sup>®</sup>
- Weight: 0.072 grams (Approximate)









Top View

Bottom View Pin Configuration

**Equivalent Circuit** 

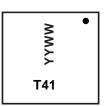
#### **Ordering Information** (Note 4)

Part Number	Case	Packaging
DMP1011LFVQ-7	PowerDI <sup>®</sup> 3333-8 (Type UX)	2,000/Tape & Reel
DMP1011LFVQ-13	PowerDI <sup>®</sup> 3333-8 (Type UX)	3,000/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

# **Marking Information**



T41 = Product Type Marking Code
YYWW = Date Code Marking
YY = Last Two Digits of Year (ex: 21 for 2021)
WW = Week Code 01 to 53



# **Maximum Ratings** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit		
Drain-Source Voltage	V <sub>DSS</sub>	-12	V		
Gate-Source Voltage	V <sub>GSS</sub>	- 6	V		
Continuous Drain Current (Note 6) V 45V	t < 10s	T <sub>A</sub> = +25°C T <sub>A</sub> = +70°C	lo	-13 -10	А
Continuous Drain Current (Note 6) V <sub>GS</sub> = 4.5V	Steady State	$T_C = +25^{\circ}C$ $T_C = +70^{\circ}C$	lo	-19 -15	А
Maximum Continuous Body Diode Forward Curr	Is	3	Α		
Pulsed Drain Current (380µs Pulse, Duty Cycle :	IDM	70	Α		
Avalanche Current (Note 7) L = 0.3mH	I <sub>AS</sub>	24	А		
Avalanche Energy (Note 7) L = 0.3mH	Eas	86	mJ		

# **Thermal Characteristics**

Characteristic	Symbol	Value	Unit	
Total Power Dissipation (Note 5)		PD	1.05	W
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	Reja	118	°C/W
Internal Resistance, Junction to Ambient (Note 5)	t < 10s	Көја	83.5	
Total Power Dissipation (Note 6)		PD	2.16	W
Thermal Resistance, Junction to Ambient (Note 6)	Steady State	D	57	°C/W
Thermal Resistance, Junction to Ambient (Note 6)	t < 10s	R <sub>θJA</sub>	40.3	
Thermal Resistance, Junction to Case (Note 6)	Rejc	11.7		
Operating and Storage Temperature Range		T <sub>J,</sub> T <sub>STG</sub>	-55 to +150	°C

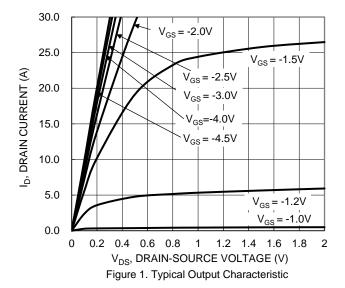
# Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 8)							
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	-12	_	_	V	$V_{GS} = 0V, I_D = -250\mu A$	
Zero Gate Voltage Drain Current T <sub>J</sub> = +25°C	IDSS	_	_	-1	μΑ	$V_{DS} = -9.6V, V_{GS} = 0V$	
Gate-Source Leakage		_	_	-100	nA	$V_{GS} = -6V$ , $V_{DS} = 0V$	
ON CHARACTERISTICS (Note 8)							
Gate Threshold Voltage	V <sub>GS(TH)</sub>	-0.6	_	-1.2	V	$V_{DS} = V_{GS}$ , $I_D = -250\mu A$	
Static Drain-Source On-Resistance	Dragon	_	9.8	11.7	mΩ	Vgs = -4.5V, ID = -12A	
Static Drain-Source On-Resistance	RDS(ON)	_	14.6	18.6		$V_{GS} = -2.5V, I_{D} = -9A$	
Diode Forward Voltage	V <sub>SD</sub>	_	-0.8	-1.0	V	V <sub>GS</sub> = 0V, I <sub>S</sub> = -16A	
DYNAMIC CHARACTERISTICS (Note 9)							
Input Capacitance	Ciss		913	_		V <sub>DS</sub> = -6V, V <sub>GS</sub> = 0V, f = 1.0MHz	
Output Capacitance	Coss	_	458	_	pF		
Reverse Transfer Capacitance	Crss	_	53	_			
Gate Resistance	Rg	_	1.85	_	Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1.0MHz$	
Total Gate Charge (V <sub>GS</sub> = -6V)	Qg	_	9.5	_			
Total Gate Charge (V <sub>GS</sub> = -4.5V)	Qg	_	7.1	_	nC	V 6V I 40A	
Gate-Source Charge	Qgs	_	1.4	_	nc nc	$V_{DS} = -6V, I_{D} = -12A$	
Gate-Drain Charge	Qgd	_	1.1				
Turn-On Delay Time	t <sub>D(ON)</sub>	_	6.3	_			
Turn-On Rise Time	tR		2.6	_		$V_{DS} = -6V$ , $V_{GS} = -4.5V$ , $R_{L} = 1\Omega$ , $R_{g} = 4.7\Omega$ , $I_{D} = -12A$	
Turn-Off Delay Time	t <sub>D(OFF)</sub>	_	14.4	_	ns		
Turn-Off Fall Time	t <sub>F</sub>		3.9				
Body Diode Reverse Recovery Time	trr		13.5	_	ns	I <sub>F</sub> = -12A, dI/dt = 100A/μs	
Body Diode Reverse Recovery Charge	Q <sub>RR</sub>		2.5	_	nC	I <sub>F</sub> = -12A, dI/dt = 100A/µs	

Notes:

- 5. Device mounted on FR-4 PC board, with minimum recommended pad layout, single sided.6. Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1-inch square copper plate.
- 7. IAs and EAs ratings are based on low frequency and duty cycles to keep T<sub>J</sub> = +25°C.
  8. Short duration pulse test used to minimize self-heating effect.
  9. Guaranteed by design. Not subject to production testing.





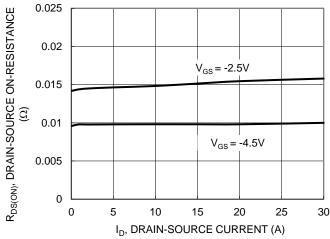


Figure 3. Typical On-Resistance vs. Drain Current and Gate Voltage

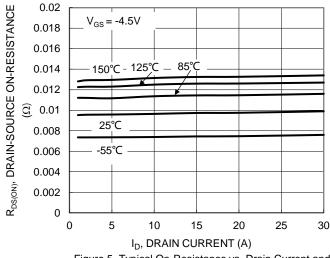
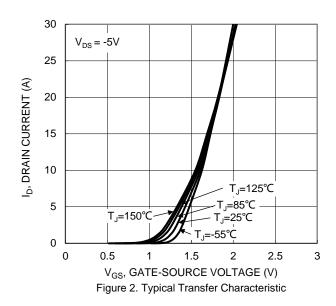


Figure 5. Typical On-Resistance vs. Drain Current and Temperature



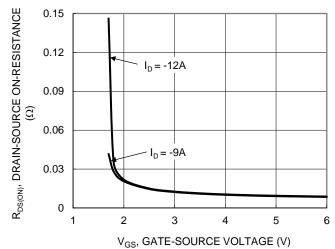


Figure 4. Typical Transfer Characteristic

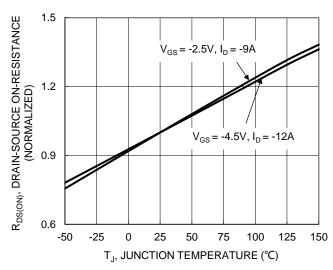


Figure 6. On-Resistance Variation with Temperature



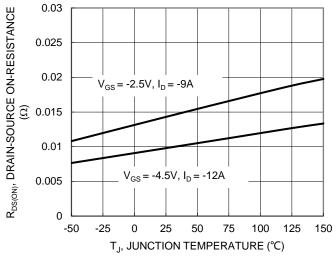


Figure 7. On-Resistance Variation with Temperature

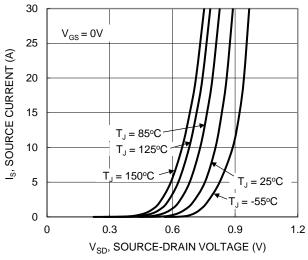


Figure 9. Diode Forward Voltage vs. Current

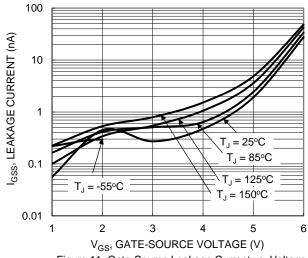


Figure 11. Gate-Source Leakage Current vs. Voltage

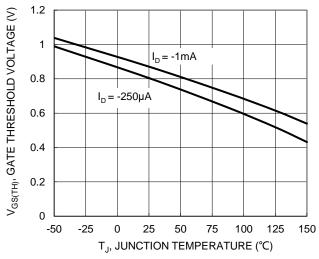


Figure 8. Gate Threshold Variation vs. Junciton Temperature

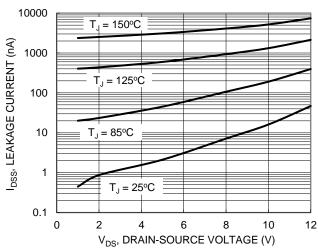
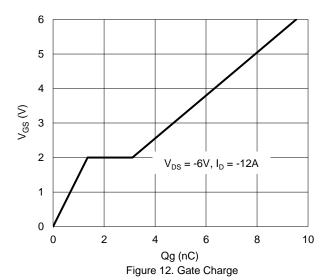
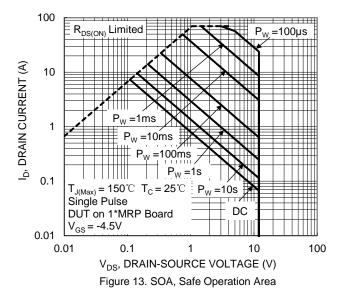


Figure 10. Typical Drain-Source Leakage Current vs.
Voltage







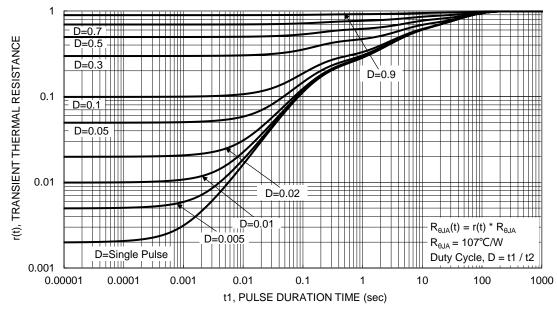


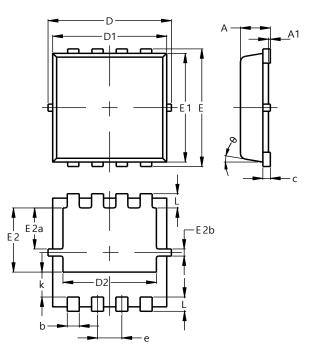
Figure 14. Transient Thermal Resistance



# **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.

### PowerDI®3333-8 (Type UX)

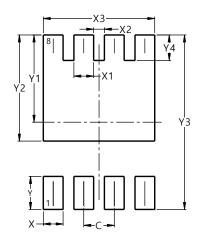


PowerDI3333-8 (Type UX)					
Dim	Min	Max	Тур		
Α	0.75	0.85	0.80		
A1	0.00	0.05			
b	0.25	0.40	0.32		
С	0.10	0.25	0.15		
D	3.20	3.40	3.30		
D1	2.95	3.15	3.05		
D2	2.30	2.70	2.50		
Е	3.20	3.40	3.30		
E1	2.95	3.15	3.05		
E2	1.60	2.00	1.80		
E2a	0.95	1.35	1.15		
E2b	0.10	0.30	0.20		
е	0.65 BSC				
k	0.50	0.90	0.70		
L	0.30	0.50	0.40		
θ	0°	12°	10°		
All Dimensions in mm					

# Suggested Pad Layout

 $\label{prop:lease} Please see \ http://www.diodes.com/package-outlines.html \ for \ the \ latest \ version.$ 

# PowerDI®3333-8 (Type UX)



Dimensions	Value (in mm)
С	0.650
Х	0.420
X1	0.420
X2	0.230
Х3	2.370
Υ	0.700
Y1	1.850
Y2	2.250
Y3	3.700
Y4	0.540



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